

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











GaAs MMIC DOUBLE-BALANCED MIXER, 4 - 8 GHz

Typical Applications

The HMC129LC4 is ideal for:

- Microwave & VSAT Radios
- Test Equipment
- Military EW, ECM, C3I

Features

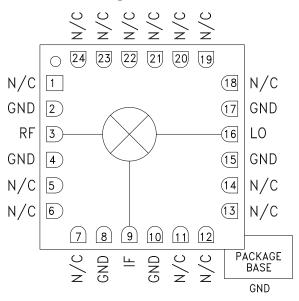
Conversion Loss: 7 dB

LO to RF and IF Isolation: 40 dB

Input IP3: +17 dBm

RoHS Compliant 4x4 mm SMT Package

Functional Diagram



General Description

The HMC129LC4 is a general purpose double-balanced MMIC mixer housed in a leadless "PB Free" RoHS-Compliant SMT package which can be used as an upconverter or downconverter in the 4 to 8 GHz band. The HMC129LC4 is ideally suited for applications where small size, no DC bias, and consistent IC performance are required. This mixer can operate over a wide LO drive input of +9 to +15 dBm. It performs equally well as a Bi-Phase modulator or demodulator. The HMC129LC4 eliminates the need for wire bonding, allowing use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25^{\circ}$ C, LO Drive = +15 dBm*

Parameter	Min.	Тур.	Max.	Units
Frequency Range, RF & LO	4.0 - 8.0			GHz
Frequency Range, IF	DC - 3.0			GHz
Conversion Loss		7	9	dB
Noise Figure (SSB)		7	9	dB
LO to RF Isolation	30	40		dB
LO to IF Isolation	32	40		dB
IP3 (Input)		17		dBm
IP2 (Input)		50		dBm
1 dB Gain Compression (Input)		10		dBm

^{*} Unless otherwise noted, all measurements performed as downconverter, IF = 100 MHz

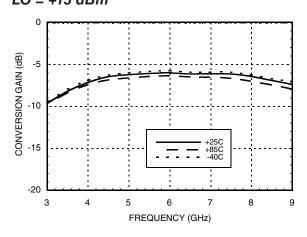
MIXER, 4 - 8 GHz



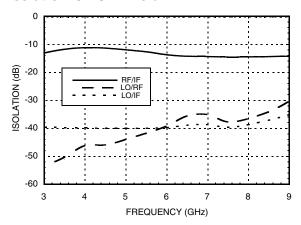
v03.0414



Conversion Gain vs. Temperature LO = +15 dBm

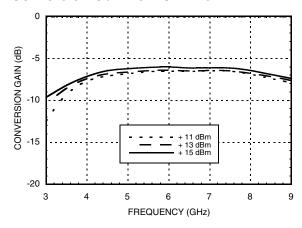


Isolation @ LO = +15 dBm

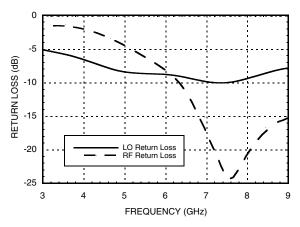


GaAs MMIC DOUBLE-BALANCED

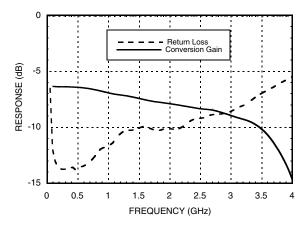
Conversion Gain vs. LO Drive



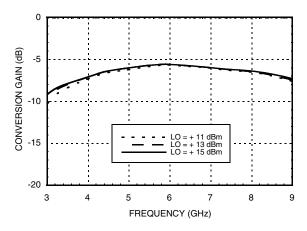
Return Loss @ LO = +15 dBm



IF Bandwidth @ LO = +15 dBm



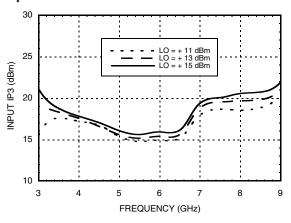
Upconverter Performance Conversion Gain vs. LO Drive



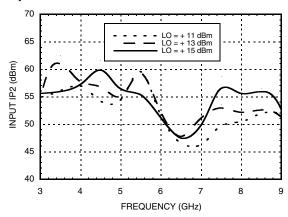




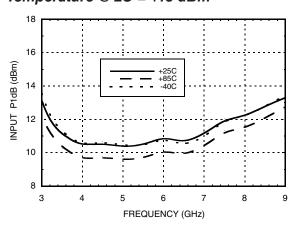
Input IP3 vs. LO Drive



Input IP2 vs. LO Drive

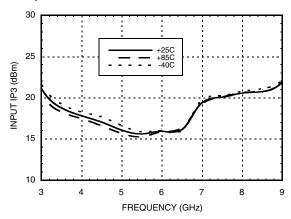


Input P1dB vs. Temperature @ LO = +15 dBm

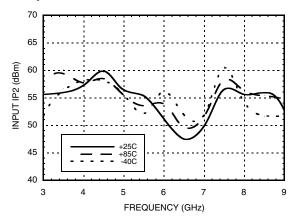


GaAs MMIC DOUBLE-BALANCED MIXER, 4 - 8 GHz

Input IP3 vs.
Temperature @ LO = +15 dBm



Input IP2 vs. Temperature @ LO = +15 dBm



Harmonics of LO

	nLO Spur @ RF Port			
LO Freq. (GHz)	1	2	3	4
3	55	47	57	68
4	42	50	42	69
5	42	54	54	56
6	39	54	40	66
7	35	55	35	63
8	35	63	45	82
9	29	45	37	81
10	15	42	35	88
LO = +15 dBm				

LO = +15 dBm

All values in dBc below input LO level measured at RF port





GaAs MMIC DOUBLE-BALANCED MIXER, 4 - 8 GHz

MxN Spurious @ IF Port

	nLO				
mRF	0	1	2	3	4
0	xx	10	25	13	41
1	9	0	33	44	46
2	78	76	70	78	86
3	88	91	87	64	81
4	97	102	104	109	110

RF Freq. = 6.1 GHz @ -10 dBm LO Freq. = 6.0 GHz @ +15 dBm Measured as downconverter

Absolute Maximum Ratings

RF/IF Input	+15 dBm	
LO Drive	+27 dBm	
IF DC Current	4 mA	
Channel Temperature	150 °C	
Continuous Pdiss (T = 85 °C) (derate 4.957 mW/ °C above 85 °C)	124 mW	
Thermal Resistance (channel to ground paddle)	131.4 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
ESD Sensitivity (HBM)	Class 1A	



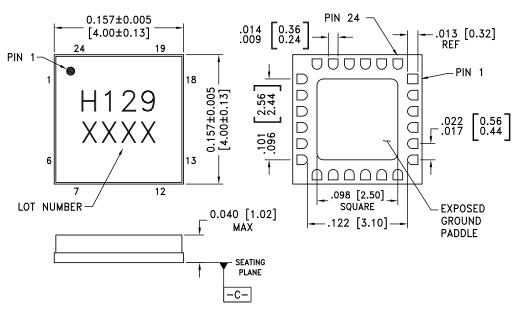




GaAs MMIC DOUBLE-BALANCED MIXER, 4 - 8 GHz

Outline Drawing

BOTTOM VIEW



NOTES:

- 1. PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING: GOLD FLASH OVER Ni
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC129LC4	Alumina, White	Gold over Nickel	MSL3 [1]	H129 XXXX

^[1] Max peak reflow temperature of 260 $^{\circ}\text{C}$

^{[2] 4-}Digit lot number XXXX





GaAs MMIC DOUBLE-BALANCED MIXER, 4 - 8 GHz

Pin Descriptions

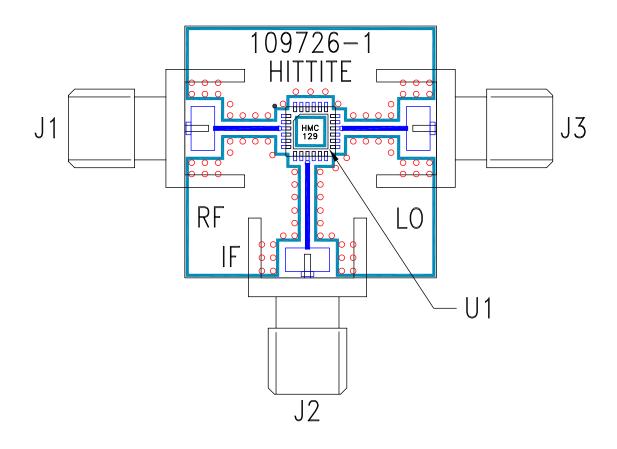
Pin Number	Function	Description	Interface Schematic
1, 5 - 7, 11 - 14, 18 - 24	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
2, 4, 8, 10, 15, 17	GND	These pins and package bottom must be connect to RF/DC ground.	GND =
3	RF	This pin is DC coupled and matched to 50 Ohms.	RF O
9	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 2 mA of current or die non-function and possible die failure will result.	IFO
16	LO	This pin is DC coupled and matched to 50 Ohms.	LO 0





GaAs MMIC DOUBLE-BALANCED MIXER, 4 - 8 GHz

Evaluation PCB



List of Materials for Evaluation PCB 109728 [1]

Item	Description
J1 - J3	PCB Mount SMA Connector
U1	HMC129LC4
PCB [2]	109726 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.







ANALOGDEVICES

GaAs MMIC DOUBLE-BALANCED MIXER, 4 - 8 GHz